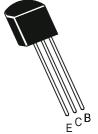




An IS/ISO 9002 and IECQ Certified Manufacturer

### NPN SILICON PLANAR EPITAXIAL TRANSISTOR

**CSC458** 



TO-92 Plastic Package

Low Frequency Amplifier.

# **Complementary CSA 1029**

ABSOLUTE MAXIMUM RATINGS (Ta=25°C unless specified otherwise)

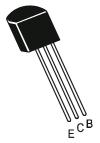
DESCRIPTION	SYMBOL	VALUE	UNIT
Collector Emitter Voltage	$V_{CEO}$	30	V
Collector Base Voltage	$V_{CBO}$	30	V
Emitter Base Voltage	$V_{EBO}$	5.0	V
Collector Current	$I_{C}$	100	mA
Emitter Current	Ι <sub>Ε</sub>	100	mA
Collector Power Dissipation	$P_{C}$	200	mW
Operating And Storage Junction Temperature Range	$T_j$ , $T_{stg}$	-55 to +150	°C

## **ELECTRICAL CHARACTERISTICS (Ta=25°C unless specified otherwise)**

$V_{CEO}$	$I_C=1$ mA, $I_E=0$	30			V
$V_{CBO}$					V
220	I <sub>C</sub> =10μΑ,I <sub>E</sub> =0	30			V
$V_{EBO}$	$I_{E}$ =10 $\mu$ A, $I_{C}$ =0	5.0			V
$I_{CBO}$	$V_{CB}$ =18V, $I_{E}$ = 0			500	nA
$I_{EBO}$	$V_{BE}$ =2V, $I_C$ = 0			500	nA
$h_{FE}$	$V_{CE}$ =12V, $I_{C}$ =2mA	100		500	
$V_{BE(on)}$	$I_C$ =2mA, $V_{CE}$ =12V			0.75	V
$V_{CE(sat)}^*$	$I_C$ =10mA, $I_B$ =1mA	<0.4		0.20	V
	$I_{CBO}$ $I_{EBO}$ $h_{FE}$ $V_{BE(on)}$	$I_{CBO}$ $V_{CB}=18V$ , $I_{E}=0$ $I_{EBO}$ $V_{BE}=2V$ , $I_{C}=0$ $I_{FE}$ $V_{CE}=12V$ , $I_{C}=2mA$ $I_{CBO}$ $I_{C}=2mA$ , $I_{C}=2mA$	$I_{CBO}$ $V_{CB}=18V$ , $I_{E}=0$ $I_{EBO}$ $V_{BE}=2V$ , $I_{C}=0$ $I_{FE}$ $V_{CE}=12V$ , $I_{C}=2mA$ 100 $I_{CE}=12V$ , $I_{CE}=12V$	$I_{CBO}$ $V_{CB}=18V$ , $I_{E}=0$ $I_{EBO}$ $V_{BE}=2V$ , $I_{C}=0$ $I_{FE}$ $V_{CE}=12V$ , $I_{C}=2mA$ 100 $I_{CE}=12V$ , $I_{C}=12V$	$\begin{array}{llllllllllllllllllllllllllllllllllll$

**CSC458** 





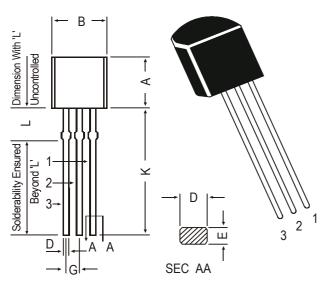
**ELECTRICAL CHARACTERISTICS (Ta=25°C unless specified otherwise)** 

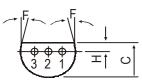
DESCRIPTION	`	•	•	TVD	MAY	LIMIT
	STWBUL	TEST CONDITION	MIN	TYP	MAX	UNIT
DYNAMIC CHARACTERISTICS						
Transition Frequency	$f_T$	$I_C$ =2mA, $V_{CE}$ =12V		230		MHz
Output Capacitance	$C_ob$	$I_E=0, V_{CB}=10V$				
•		f=1MHz		3.5		pF
Input Impedance	h <sub>ie</sub>				16.5	KΩ
	ie					
		$I_{C}$ =0.1mA, $V_{CE}$ =5V				
		f=270Hz				
Output Admittance	h	1-270112		11		
Output Admittance	$h_{oe}$			1.1		μs
						6
Voltage Feedback Ratio	$h_{re}$			70		x10 <sup>-6</sup>
Small Signal Current Gain	h <sub>fe</sub>			130		
Noise Figure	NF	$V_{CE} = 6V, I_{C} = 0.1 \text{mA}$			10	dB
-		Rg=5001K $\Omega$ , f=1KH <sub>7</sub>				
		<b>5</b> ,				
h <sub>FE</sub> CLASSIFICATION:	В:	C:		):		
	100-200	160-320		0-500		

# **TO-92 Plastic Package**

## **TO-92 Plastic Package**

### **TO-92 Transistors on Tape and Ammo Pack**



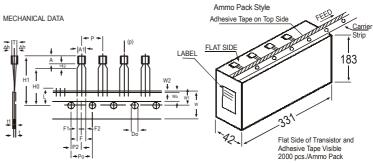


#### PIN CONFIGURATION

- 1. BASE
- 2. COLLECTOR
- 3. EMITTER

DIM	MIN.	MAX.				
Α	4.32	5.33				
В	4.45	5.20				
С	3.18	4.19				
D	0.41	0.55				
Е	0.35	0.50				
F	5 DEG					
G	1.14	1.40				
Н	1.14	1.53				
K	12.70	_				
L	1.982	2.082				

All diminsions in mm.



#### All dimensions in mm unless specified otherwise

ITEM	0)/14001	SPECIFICATION			DEMARKS	
ITEIVI	SYMBOL	MIN.	NOM.	MAX.	TOL.	REMARKS
BODY WIDTH BODY HEIGHT BODY THICKNESS PITCH OF COMPONENT	A1 A T P	4.0 4.8 3.9	12.7	4.8 5.2 4.2	±1	
FEED HOLE CENTRE TO	Po		12.7		±0.3	CUMULATIVE PITCH ERROR 1.0 mm/20 PITCH
COMPONENT CENTRE	P2		6.35		±0.4	TO BE MEASURED AT BOTTOM OF CLINCH
DISTANCE BETWEEN OUTER LEADS COMPONENT ALIGNMENT TAPE WIDTH HOLD-DOWN TAPE WIDTH HOLE POSITION	F △h W Wo W1		5.08 0 18 6 9	1	+0.6 -0.2 ±0.5 ±0.2 +0.7 -0.5	AT TOP OF BODY
HOLD-DOWN TAPE POSITION LEAD WIRE CLINCH HEIGHT COMPONENT HEIGHT LENGTH OF SNIPPED LEADS FEED HOLE DIAMETER TOTAL TAPE THICKNESS LEAD - TO - LEAD DISTANCEF1,	W2 Ho H1 L Do t		0.5 16 4 2.54	23.25 11.0 1.2	±0.2 ±0.5 ±0.2 +0.4	t1 0.3 - 0.6
CLINCH HEIGHT PULL - OUT FORCE	H2 (P)	6N		3	-0.1	

- NOTES

  1. MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2 mm.
- MAXIMUM NON-CUMULATIVE VARIATION BETWEEN TAPE FEED HOLES SHALL NOT EXCEED 1 mm IN 20
- PITCHES.
  HOLDDOWN TAPE NOT TO EXCEED BEYOND THE EDGE(S) OF CARRIER TAPE AND THERE SHALL BE NO EXPOSURE OF ADHESIVE.
  NO MORE THAN 3 CONSECUTIVE MISSING COMPONENTS ARE PERMITTED.
  A TAPE TRAILER, HAVING AT LEAST THREE FEED HOLES ARE REQUIRED AFTER THE LAST COMPONENT.
  SPLICES SHALL NOT INTERFERE WITH THE SPROCKET FEED HOLES.

## **Packing Detail**

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

Notes CSC458

TO-92 Plastic Package

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